

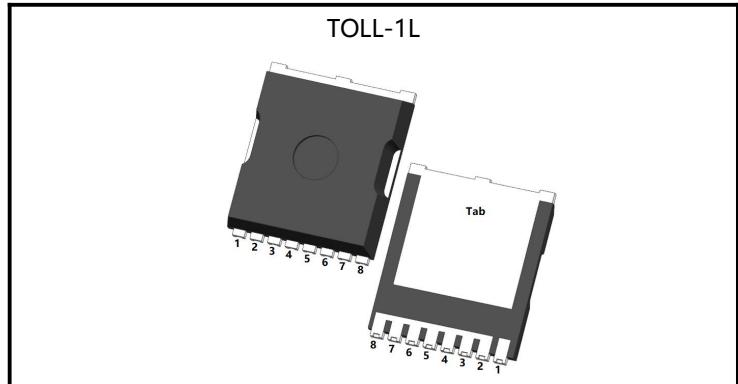


MOSFET

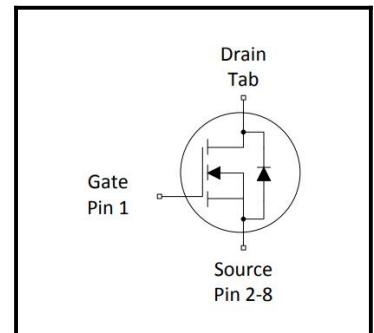
240 Amps, 80 Volts N-CHANNEL MOSFET

FEATURE

- ◆ Low gate charge
- ◆ Low Ciss
- ◆ Fast switching
- ◆ 100% avalanche tested
- ◆ Improved dv/dt capability
- ◆ RoHS 2.0 Compliant



Parameter	Values	Unit
Bvdss	80	V
Id	240	A
Rdson(max)	1.8	mΩ



Ordering Code	Marking	Package	Packaging
PW018N08TS	PW018N08TS	TOLL-1L	Tape and reel



Absolute Maximum Ratings($T_C=25^\circ\text{C}$,unless otherwise noted)

Parameter	Symbol	Values			Unit	Note/Test Conditions
		Min	Typ	Max		
Drain-Source Voltage	V_{DSS}	-	-	80	V	-
Gate-Source Voltage	V_{GS}	-20	-	20	V	-
Continuous Drain Current(Package Limited)	I_D	-	-	240	A	$T_C=25^\circ\text{C}$
		-	-	144	A	$T_C=100^\circ\text{C}$
Pulsed Drain Current(Note1)	I_{DM}	-	-	720	A	-
Single Pulse Avalanche Energy	E_{AS}	-	-	529	mJ	$L=0.5\text{mH}, V_D=80\text{V}, T_C=25^\circ\text{C}$
Maximum Power Dissipation	P_D	-	-	272	W	$T_C=25^\circ\text{C}$
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55	-	175	$^\circ\text{C}$	-
Maximum lead temperature for soldering purposes, 1/8"from case for 5 seconds	T_L	-	-	260	$^\circ\text{C}$	-

Thermal Characteristics

Parameter	Symbol	Values			Unit	Note/Test Conditions
		Min	Typ	Max		
Thermal resistance , Channel to Case	$R_{th(ch-c)}$	-	-	0.55	$^\circ\text{C}/\text{W}$	-

Electrical Characteristics ($T_C=25^\circ\text{C}$,unless otherwise noted)

Static characteristics

Parameter	Symbol	Values			Unit	Note/Test Conditions
		Min	Typ	Max		
Drain-Source Breakdown Voltage	BV_{DSS}	80	-	-	V	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$
Zero Gate Voltage Drain Current	I_{DSS}	-	-	1	μA	$V_{DS}=80\text{V}, V_{GS}=0\text{V}$
Gate-Body Leakage Current,Forward	I_{GSSF}	-	-	100	nA	$V_{GS}=20\text{V}, V_{DS}=0\text{V}$
Gate-Body Leakage Current,Reverse	I_{GSSR}	-	-	-100	nA	$V_{GS}=-20\text{V}, V_{DS}=0\text{V}$
Gate-Source Threshold Voltage	$V_{GS(th)}$	2.0	-	4.0	V	$V_{DS}=V_{GS}, I_D=250\mu\text{A}$
Drain-Source On-State Resistance	$R_{DS(on)}$	-	1.4	1.8	$\text{m}\Omega$	$V_{GS}=10\text{V}, I_D=20\text{A}$
Gate Resistance	R_g	-	1.6	-	Ω	$V_{GS}=0\text{V}, V_{DS} \text{ Open}, f=1\text{MHz}$
Forward Transconductance	g_{fs}	-	18	-	S	$V_{DS}=5\text{V}, I_D=20\text{A}$



Dynamic characteristics

Parameter	Symbol	Values			Unit	Note/Test Conditions
		Min	Typ	Max		
Input Capacitance	C _{iss}	-	12780	-	pF	V _{DS} =25V,V _{GS} =0V,f=1.0MHZ
Output Capacitance	C _{oss}	-	3264	-	pF	V _{DS} =25V,V _{GS} =0V,f=1.0MHZ
Reverse Transfer Capacitance	C _{rss}	-	262	-	pF	V _{DS} =25V,V _{GS} =0V,f=1.0MHZ
Turn-On Delay Time	t _{d(on)}	-	39	-	ns	V _{DD} =42.5V,R _G =3Ω,V _{GS} =10V,I _D =10A
Turn-On Rise Time	t _r	-	122	-	ns	V _{DD} =42.5V,R _G =3Ω,V _{GS} =10V,I _D =10A
Turn-Off Delay Time	t _{d(off)}	-	115	-	ns	V _{DD} =42.5V,R _G =3Ω,V _{GS} =10V,I _D =10A
Turn-Off Fall Time	t _f	-	137	-	ns	V _{DD} =42.5V,R _G =3Ω,V _{GS} =10V,I _D =10A

Gate charge characteristics

Parameter	Symbol	Values			Unit	Note/Test Conditions
		Min	Typ	Max		
Total Gate Charge	Q _g	-	233.5	-	nC	V _{DS} =64V,I _D =20A,V _{GS} =10V
Gate-Source Charge	Q _{gs}	-	65.9	-	nC	V _{DS} =64V,I _D =20A,V _{GS} =10V
Gate-Drain Charge	Q _{gd}	-	62.0	-	nC	V _{DS} =64V,I _D =20A,V _{GS} =10V

Reverse diode

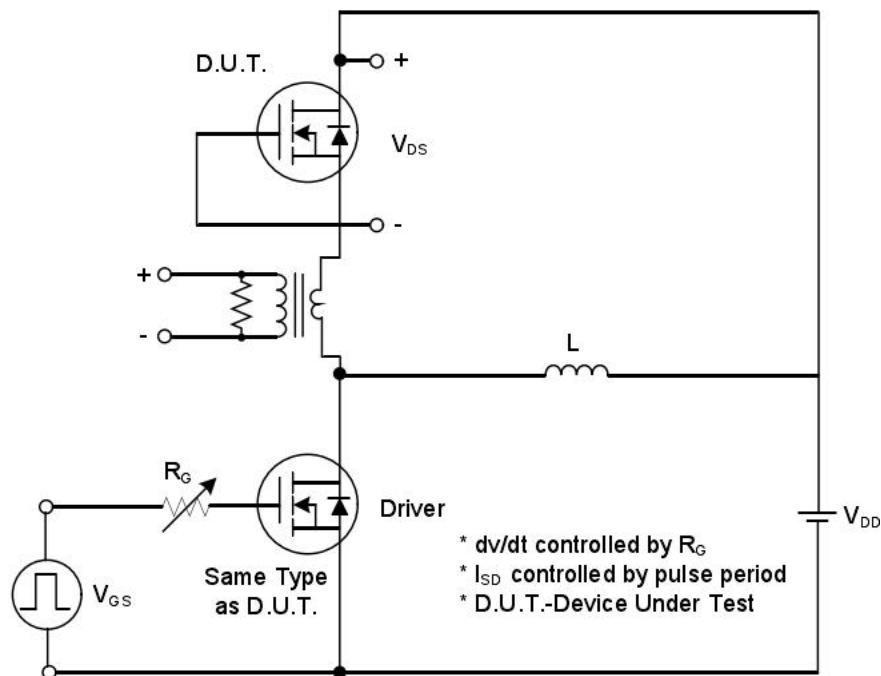
Parameter	Symbol	Values			Unit	Note/Test Conditions
		Min	Typ	Max		
Continuous Diode Forward Current	I _S	-	-	240	A	-
Pulsed Diode Forward Current	I _{SM}	-	-	720	A	-
Diode Forward Voltage	V _{SD}	-	-	1.2	V	I _S =20A,V _{GS} =0V
Reverse Recovery Time	t _{rr}	-	130	-	ns	V _D =30V,I _F =1A
Reverse Recovery Charge	Q _{rr}	-	311	-	nC	di/dt=100A/μs,(Note2)

Notes

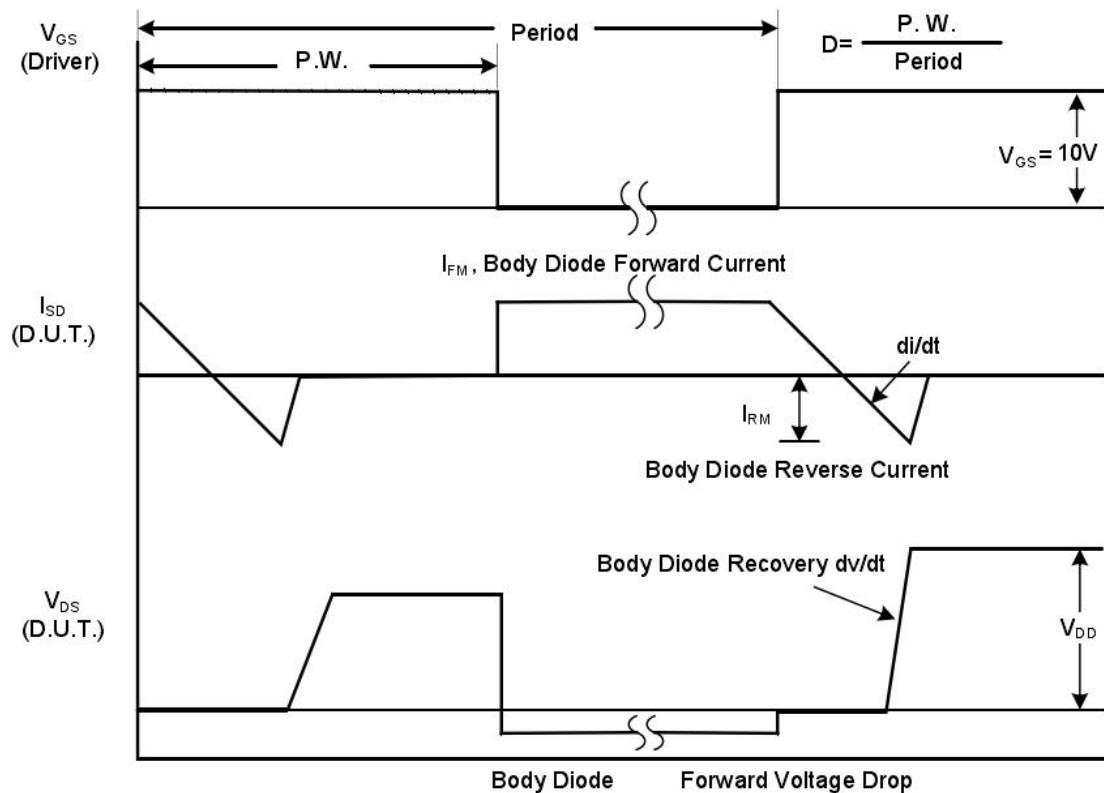
- Repetitive Rating:pulse width limited by maximum junction temperature.
- Pulse width≤300us,duty cycle≤2%.



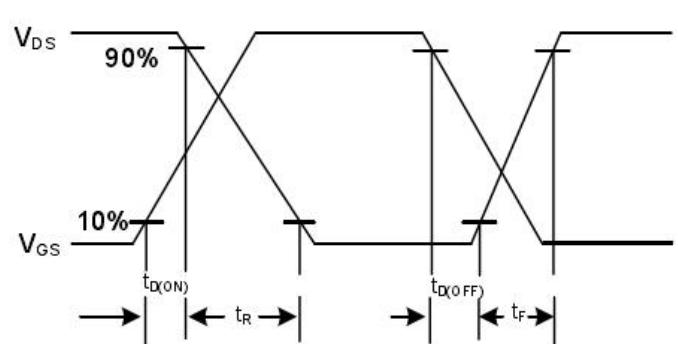
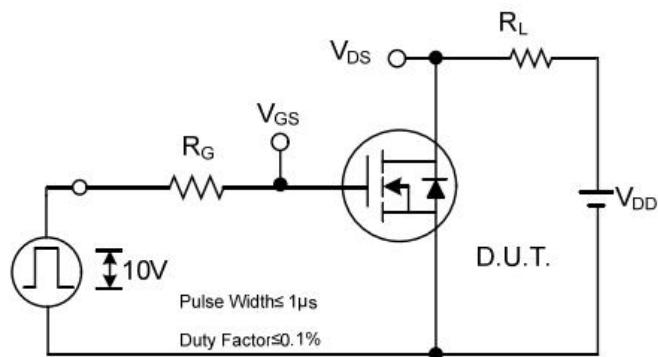
RATING AND CHARACTERISTIC CURVES



Peak Diode Recovery dv/dt Test Circuit

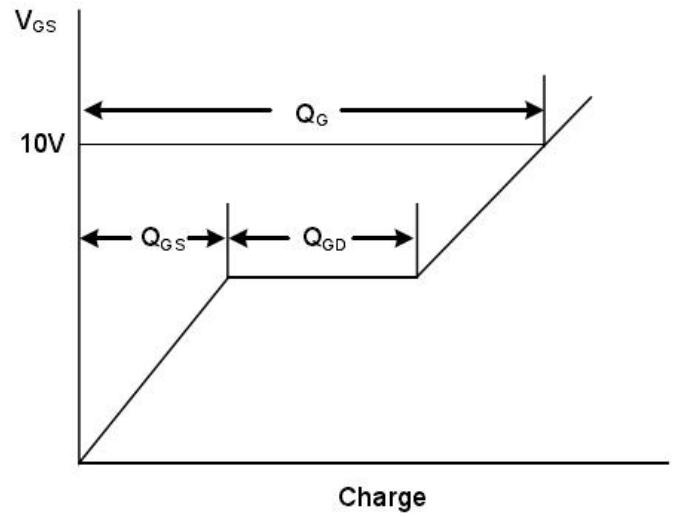
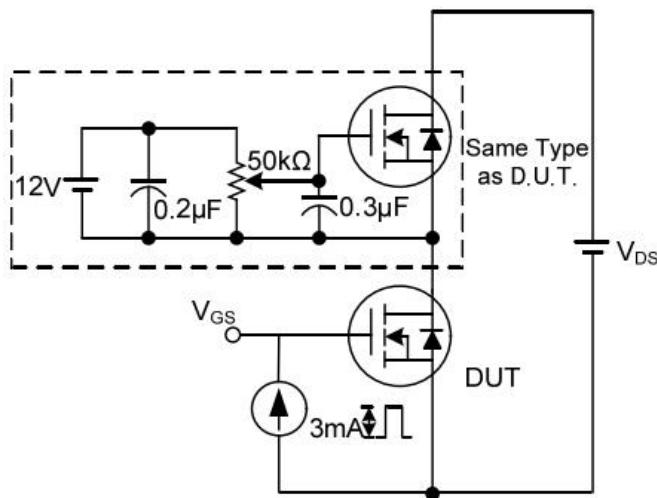


Peak Diode Recovery dv/dt Waveforms



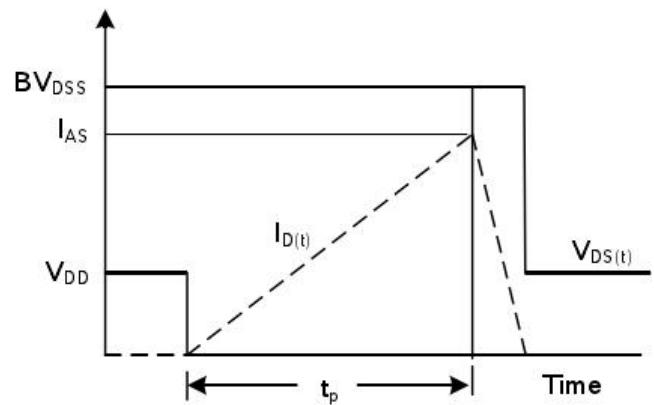
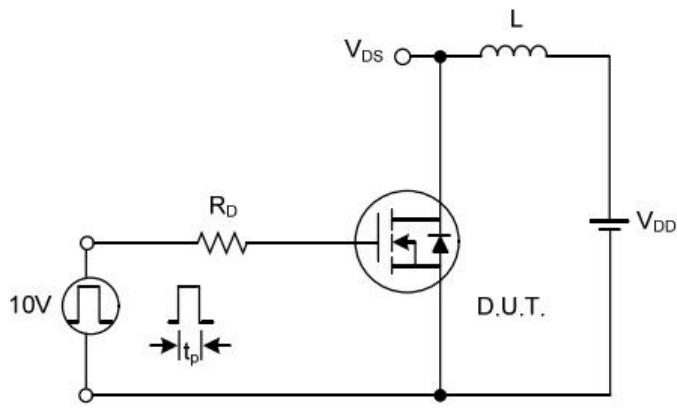
Switching Test Circuit

Switching Waveforms



Gate Charge Test Circuit

Gate Charge Waveform



Unclamped Inductive Switching Test Circuit

Unclamped Inductive Switching Waveforms



RATING AND CHARACTERISTIC CURVES

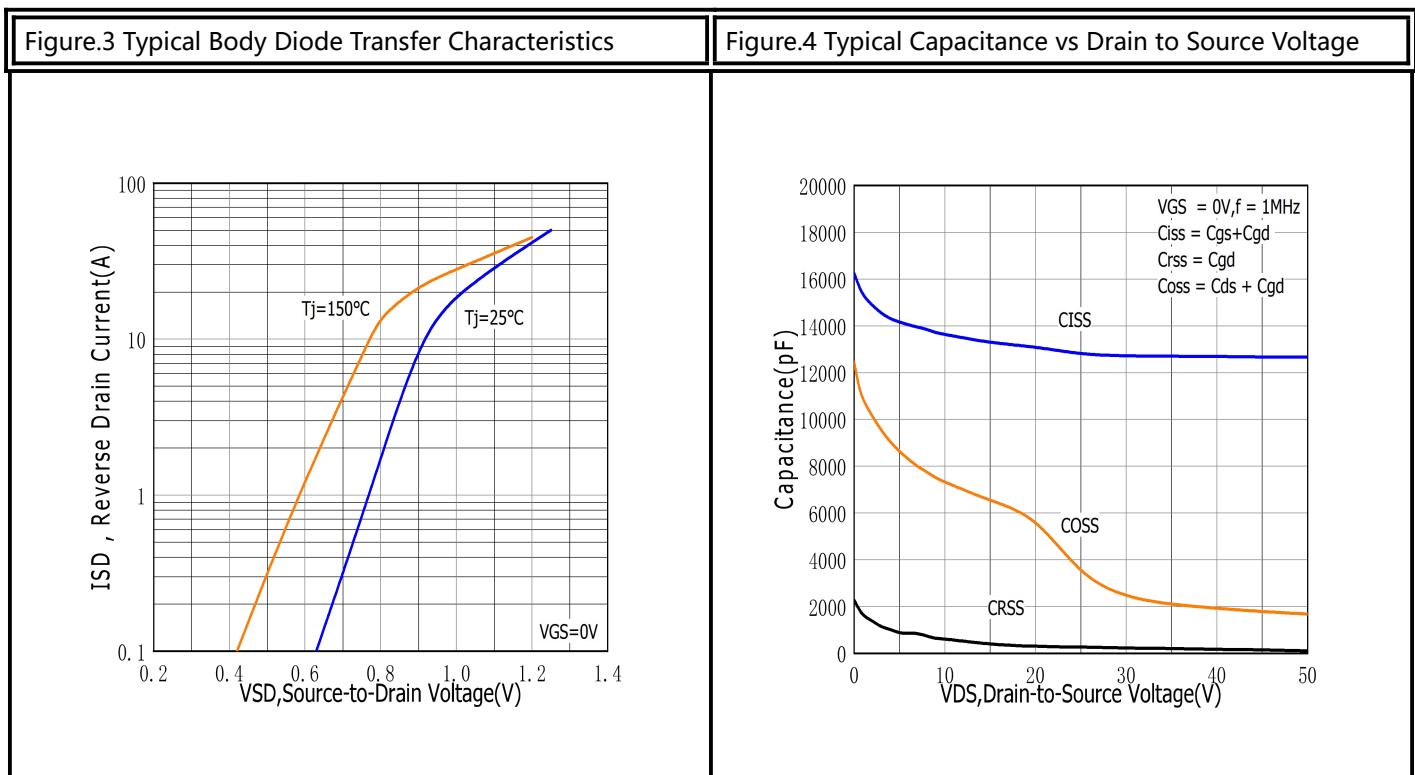
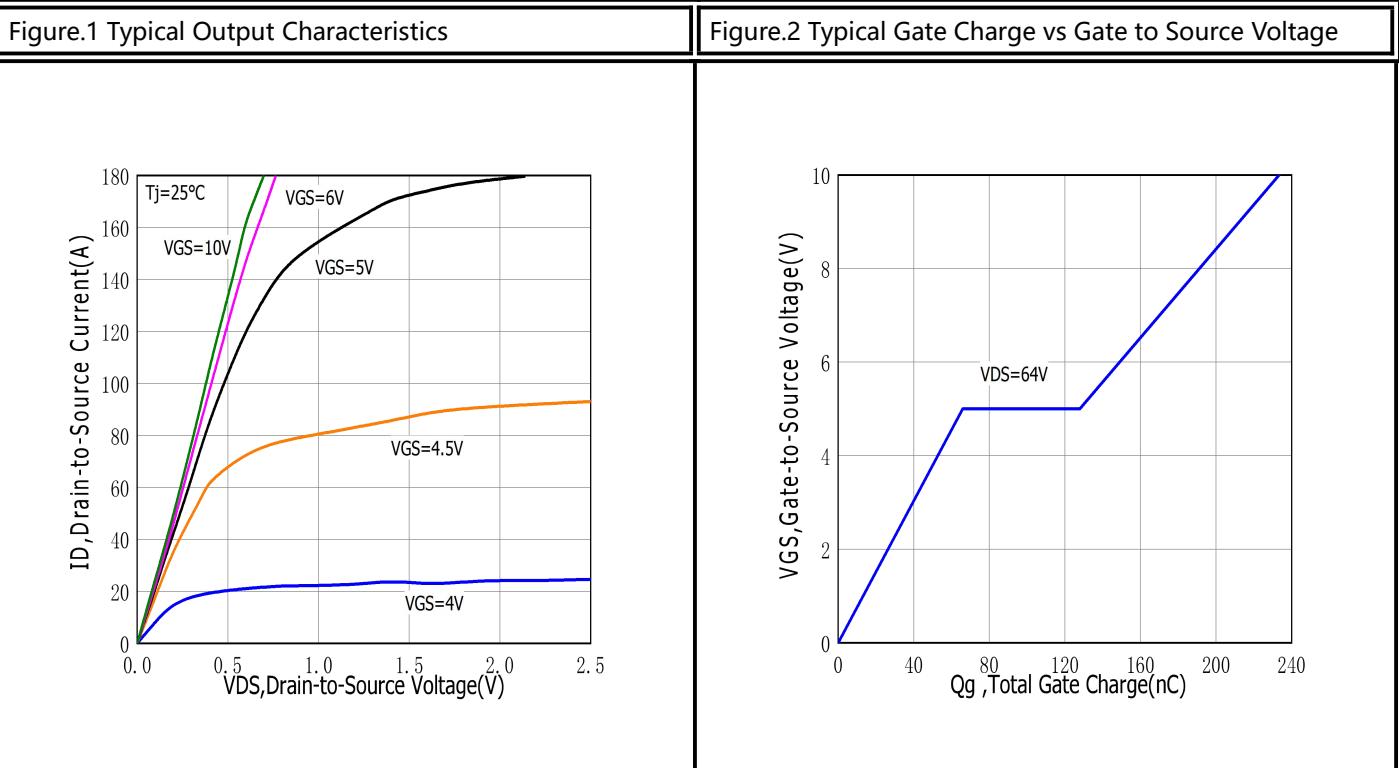




Figure.5 Typical Breakdown Voltage vs Junction Temperature

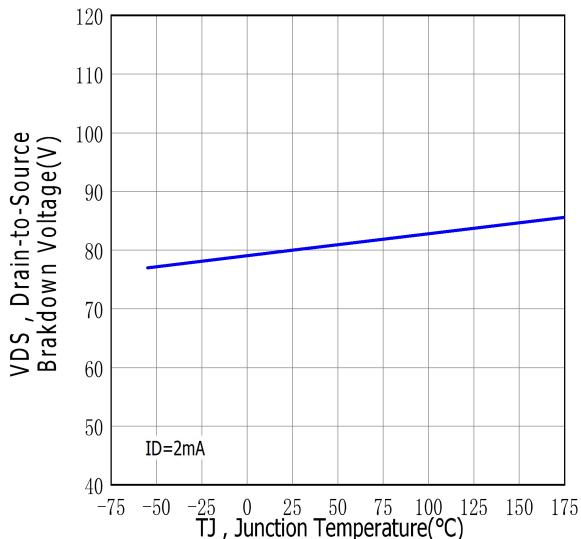


Figure.6 Typical Drain to Source On Resistance vs Junction Temperature

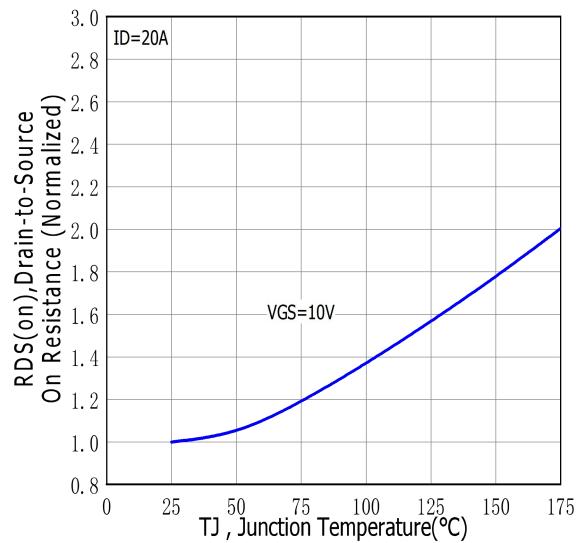


Figure.7 Maximum Forward Bias Safe Operating Area

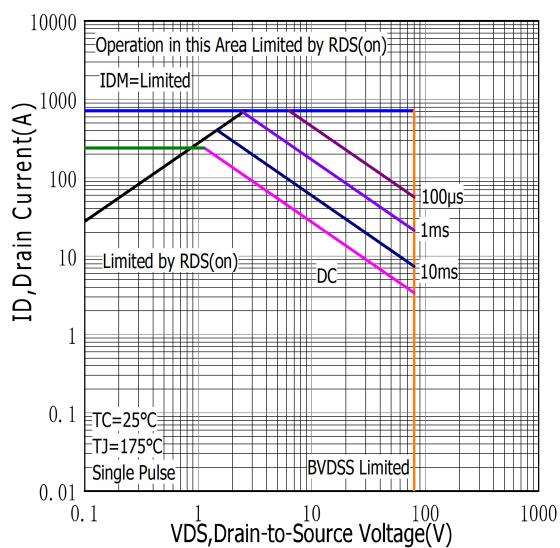


Figure.8 Typical Drain to Source ON Resistance vs Drain Current

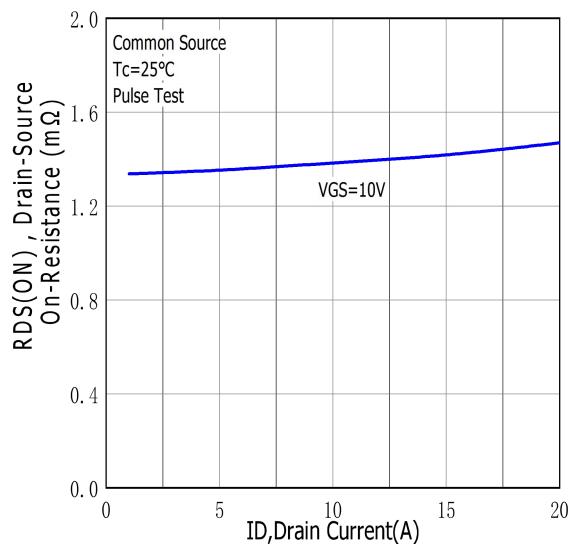




Figure.9 Maximum EAS vs Channel Temperature

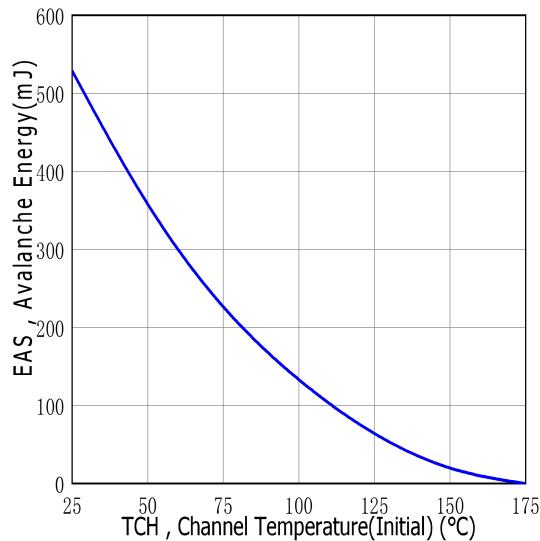


Figure.10 Typical Threshold Voltage vs Case Temperature

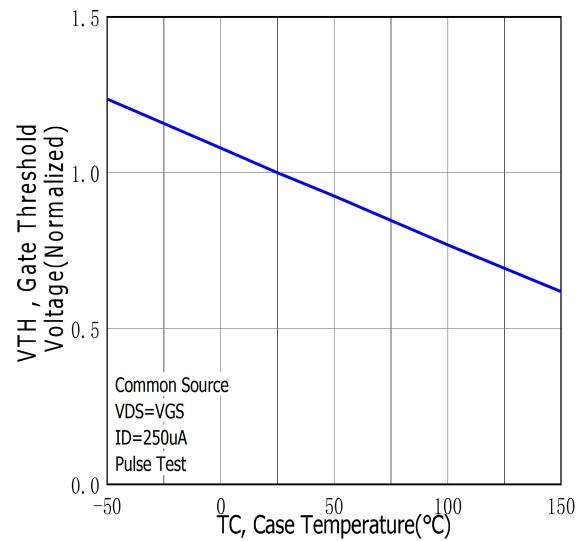


Figure.11 Typical Transfer Characteristics

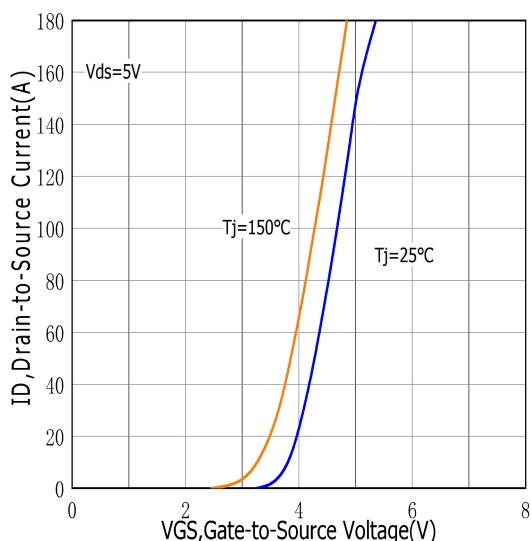


Figure.12 Maximum Power Dissipation vs Case Temperature

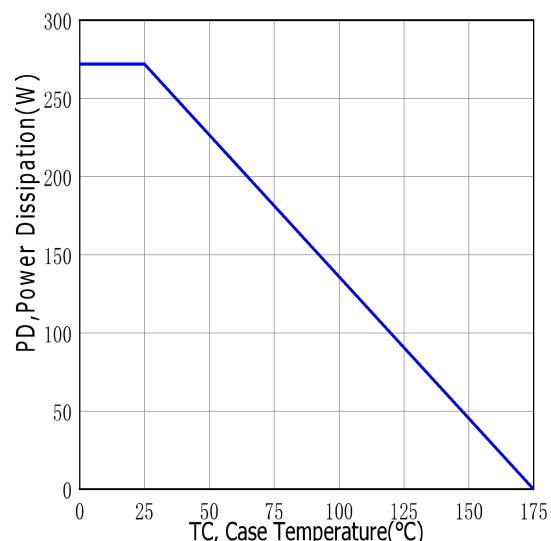
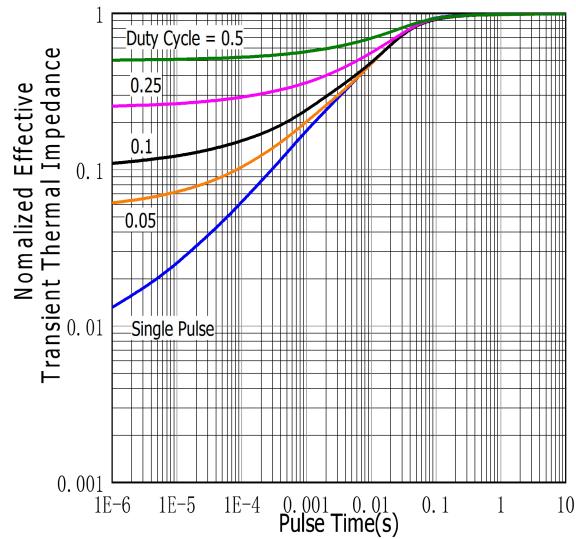
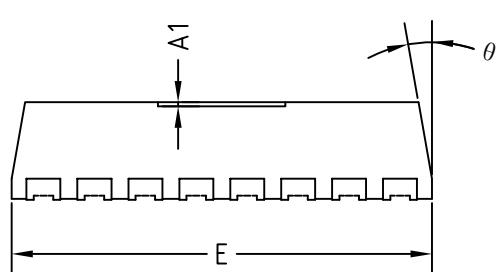
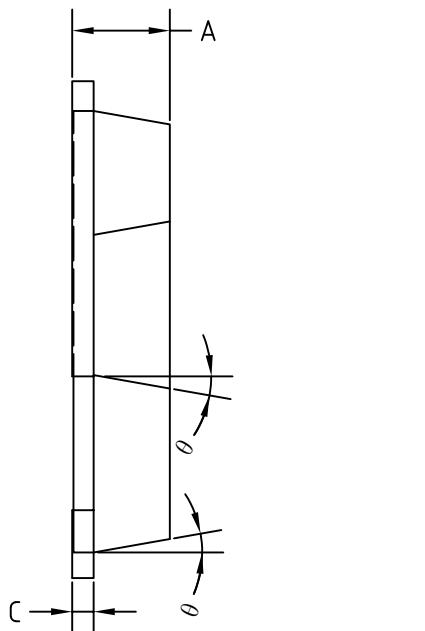
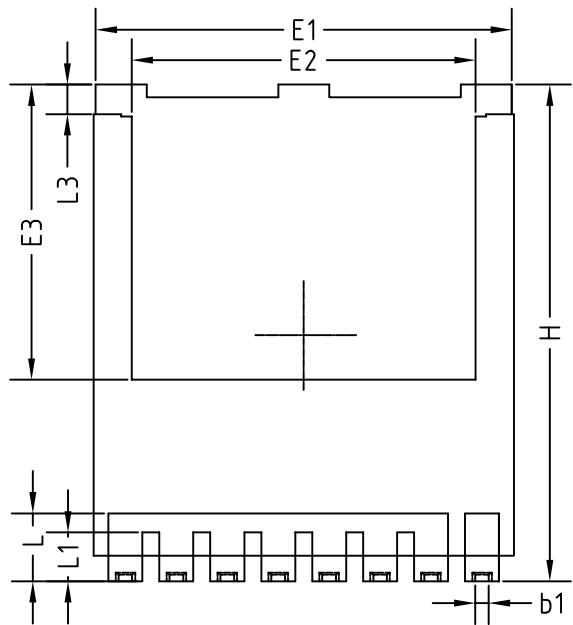
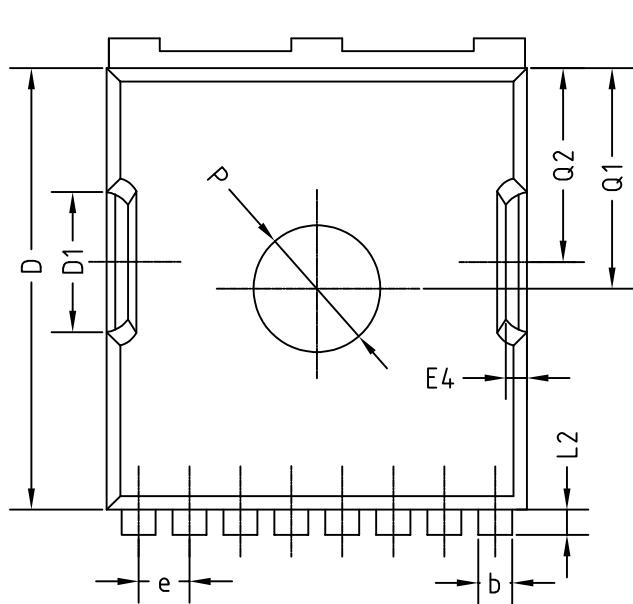




Figure.13 Maximum Effective Thermal Impedance , Junction to Case



TOLL-1L PACKAGE OUTLINE



COMMON DIMENSIONS						
DIM	MILLIMETERS			INCHES		
	MIN	NOR	MAX	MIN	NOR	MAX
A	2.20	2.30	2.40	0.087	0.091	0.094
A1	0.05	0.10	0.20	0.00	0.004	0.008
b	0.65	0.80	0.85	0.026	0.031	0.033
b1	0.30	0.40	0.50	0.012	0.016	0.020
C	0.35	0.46	0.65	0.014	0.018	0.026
D	10.35	10.55	10.70	0.407	0.415	0.421
D1	3.15	3.30	3.45	0.124	0.130	0.136
E	9.80	9.90	10.00	0.386	0.390	0.394
E1	9.65	9.80	9.95	0.380	0.386	0.392
E2	7.90	8.10	8.30	0.311	0.319	0.327
E3	6.80	7.0	7.20	0.268	0.276	0.283
E4	0.30	0.50	0.75	0.012	0.02	0.03
e	1.15	1.20	1.25	0.045	0.047	0.049
L	1.35	1.60	1.85	0.053	0.063	0.073
L1	0.95	1.20	1.35	0.037	0.045	0.053
L2	0.40	0.60	0.80	0.016	0.024	0.031
L3	0.60	0.70	0.85	0.024	0.024	0.031
theta	7°	10°	12°	7°	10°	12°
P	2.90	3.00	3.10	0.114	0.118	0.122
Q	4.50	4.60	4.70	0.177	0.181	0.185
Q1	5.10	5.20	5.30	0.201	0.205	0.209
H	11.55	11.70	11.95	0.455	0.461	0.470

UNIT: mm

NOTE: 测量不包含毛刺、飞边。